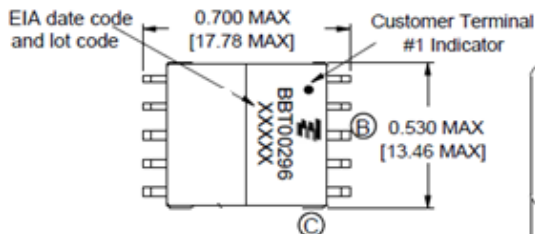
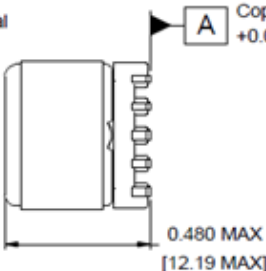
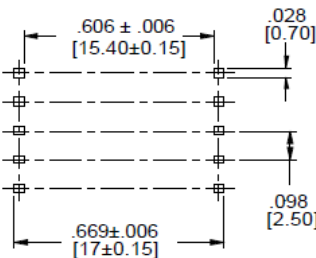
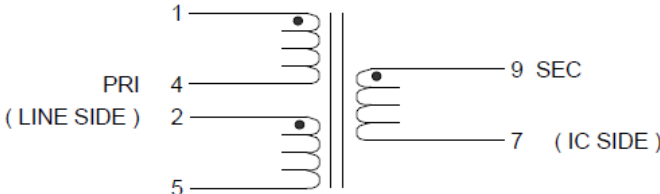


MGBBT-00296-P	REV																																																																																					
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Product Description	XFMR EP13 SMD, ROHS MGBBT-00114 Previously MGBBT-00296																																																																																					
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